

# **GENERAL DESCRIPTION**

The 83904-02 is a low skew, high performance 1-to-4 Crystal-to-LVCMOS Fanout Buffer. The 83904-02 has selectable single-ended clock or two crystal-oscillator inputs. There is an output enable to disable the outputs by placing them into a high-impedance state.

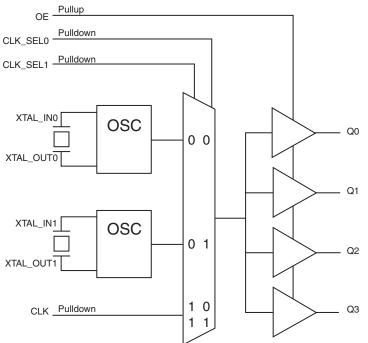
Guaranteed output and part-to-part skew characteristics make the 83904-02 ideal for those applications demanding well defined performance and repeatability.

# **F**EATURES

- Four LVCMOS/LVTTL outputs, 19 $\Omega$  typical output impedance @ V<sub>DD</sub> = V<sub>DDO</sub> = 3.3V
- Two Crystal oscillator input pairs One LVCMOS/LVTTL clock input
- Crystal input frequencry range: 12MHz 38.88MHz
- Output frequency: 200MHz (maximum)
- Output Skew: 40ps (maximum) @ V<sub>DD</sub> = V<sub>DDD</sub> = 3.3V
- RMS phase jitter @ 25MHz output, using a 25MHz crystal  $(100Hz - 1MHz): 0.16ps (typical) @ V_{DD} = V_{DDD} = 3.3V$
- RMS phase noise at 25MHz:

Offset	Noise Power
100Hz	118.4 dBc/Hz
1kHz	141.5 dBc/Hz
10kHz	157.2 dBc/Hz
100kHz	157.2 dBc/Hz

- Supply Voltage Modes: (Core/Output) 3.3V/3.3V 3.3V/2.5V 3.3V/1.8V 2.5V/2.5V 2.5V/1.8V
- 0°C to 70°C ambient operating temperature
- Available in lead-free (RoHS 6) package



# **PIN ASSIGNMENT**

CLK_SEL0	1	16 VDDO
XTAL_OUT0		15 🗖 Q0
XTAL_IN0	3	14 🗖 Q1
VDD	4	13 🗖 GND
XTAL_IN1	5	12 🗖 Q2
XTAL_OUT1	6	11 🗖 Q3
CLK_SEL1	7	10 🗖 Vddo
CLK	8	9 🗖 OE

83904-02 16-Lead TSSOP 4.4mm x 5.0mm x 0.92mm package body **G** Package **Top View** 

**BLOCK DIAGRAM** 

### TABLE 1. PIN DESCRIPTIONS

Number	Name	т	уре	Description
1, 7	CLK_SEL0, CLK_SEL1	Input	Pulldown	Clock select inputs. See Table 3, Input Reference Function Table. LVCMOS / LVTTL interface levels.
2, 3	XTAL_OUT0, XTAL_IN0	Input		Crystal oscillator interface. XTAL_IN0 is the input. XTAL_OUT0 is the output.
4	V	Power		Positive supply pin.
5, 6	XTAL_IN1, XTAL_OUT1	Input		Crystal oscillator interface. XTAL_IN1 is the input. XTAL_OUT1 is the output.
8	CLK	Input	Pulldown	Single-ended clock input. LVCMOS/LVTTL interface levels.
9	OE	Input	Pullup	Output enable. When LOW, outputs are in HIGH impedance state. When HIGH, outputs are active. LVCMOS / LVTTL interface levels.
10, 16	V	Power		Output supply pins.
11, 12, 14, 15	Q3, Q2, Q1, Q0	Output		Single-ended clock outputs. LVCMOS/LVTTL interface levels.
13	GND	Power		Power supply ground.

NOTE: Pullup and Pulldown refer to internal input resistors. See Table 2, Pin Characteristics, for typical values.

### TABLE 2. PIN CHARACTERISTICS

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C	Input Capacitance			4		pF
R	Input Pullup Resistor			51		kΩ
R	Input Pulldown Resistor			51		kΩ
		V <sub>DDO</sub> = 3.465V		8		pF
	Power Dissipation Capacitance (per output)	V <sub>DDO</sub> = 2.625V		7		pF
		V <sub>DD0</sub> = 2.0V		7		pF
		V <sub>DD0</sub> = 3.3V		19		Ω
R <sub>out</sub>	Output Impedance	$V_{DDO} = 2.5V$		21		Ω
		$V_{DDO} = 1.8V$		32		Ω

#### TABLE 3. INPUT REFERENCE FUNCTION TABLE

Contro	l Inputs	Reference
CLK_SEL1	CLK_SEL0	nelelelice
0	0	XTAL0 (default)
0	1	XTAL1
1	0	CLK
1	1	CLK

# RENESAS

### ABSOLUTE MAXIMUM RATINGS

Supply Voltage, $V_{dd}$	4.6V
Inputs, V	-0.5V to $V_{_{DD}}$ + 0.5 V
Outputs, $V_{o}$	-0.5V to $V_{\text{DDO}}$ + 0.5V
Package Thermal Impedance, $\boldsymbol{\theta}_{_{\!$	100.3°C/W (0 mps)
Storage Temperature, T	-65°C to 150°C

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

# Table 4A. Power Supply DC Characteristics, $V_{dd} = V_{dd0} = 3.3V \pm 5\%$ , Ta = 0°C to 70°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V	Power Supply Voltage		3.135	3.3	3.465	V
V	Output Supply Voltage		3.135	3.3	3.465	V
	Power Supply Current	No Load & XTALx selected @ 12MHz			7	mA
DD		No Load & CLK selected			1	mA
	Output Supply Current	No Load & CLK selected			1	mA

# TABLE 4B. Power Supply DC Characteristics, $V_{DD} = 3.3V \pm 5\%$ , $V_{DDD} = 2.5V \pm 5\%$ , TA = 0°C to 70°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V	Power Supply Voltage		3.135	3.3	3.465	V
V	Output Supply Voltage		2.375	2.5	2.625	V
	Power Supply Current	No Load & XTALx selected @ 12MHz			7	mA
DD		No Load & CLK selected			1	mA
	Output Supply Current	No Load & CLK selected			1	mA

# TABLE 4C. Power Supply DC Characteristics, $V_{DD} = 3.3V \pm 5\%$ , $V_{DDD} = 1.8V \pm 0.2V$ , TA = 0°C to 70°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
	Power Supply Voltage		3.135	3.3	3.465	V
V	Output Supply Voltage		1.6	1.8	2.0	V
	Power Supply Current	No Load & XTALx selected @ 12MHz			7	mA
DD		No Load & CLK selected			1	mA
	Output Supply Current	No Load & CLK selected			1	mA

# TABLE 4D. Power Supply DC Characteristics, $V_{DD} = V_{DDO} = 2.5V \pm 5\%$ , TA = 0°C to 70°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V	Power Supply Voltage		2.375	2.5	2.625	V
V <sub>DDO</sub>	Output Supply Voltage		2.375	2.5	2.625	V
	Power Supply Current	No Load & XTALx selected @ 12MHz			3	mA
DD		No Load & CLK selected			1	mA
	Output Supply Current	No Load & CLK selected			1	mA

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V	Power Supply Voltage		2.375	2.5	2.625	V
V	Output Supply Voltage		1.6	1.8	2.0	V
	Power Supply Current	No Load & XTALx selected @ 12MHz			3	mA
DD		No Load & CLK selected			1	mA
	Output Supply Current	No Load & CLK selected			1	mA

# Table 4E. Power Supply DC Characteristics, $V_{_{DD}}$ = 2.5V±5%, $V_{_{DDO}}$ = 1.8V±0.2V, Ta = 0°C to 70°C

# Table 4F. DC Characteristics, $T_{\text{A}}=0^{\circ}C$ to $70^{\circ}C$

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
V	Input High Voltage		$V_{_{DD}} = 3.3V \pm 5\%$	2.2		V <sub>DD</sub> + 0.3	V
V <sub>IH</sub>	Input High Voltage		$V_{_{DD}} = 2.5V \pm 5\%$	1.6		V <sub>DD</sub> + 0.3	V
V	Input Low Voltage		$V_{_{DD}} = 3.3V \pm 5\%$	-0.3		1.3	V
V	Input Low Voltage		$V_{_{DD}} = 2.5V \pm 5\%$	-0.3		0.9	V
I.	Input High Current	CLK, CLK_ SEL0:1	$V_{_{DD}} = 3.3 V \text{ or } 2.5 V \pm 5\%$			150	μA
IH		OE	$V_{_{DD}} = 3.3 V \text{ or } 2.5 V \pm 5\%$			5	μA
I.	Input Low Current	CLK, CLK_ SEL0:1	$V_{_{DD}} = 3.3 V \text{ or } 2.5 V \pm 5\%$	-5			μA
ĨL		OE	$V_{_{DD}} = 3.3 V \text{ or } 2.5 V \pm 5\%$	-150			μA
			$V_{_{DDO}} = 3.3V \pm 5\%; \text{ NOTE 1}$	2.6			V
V <sub>oh</sub>	Output HighVoltage	I.	V <sub>DD0</sub> = 2.5V ± 5%; NOTE 1	1.8			V
			$V_{_{DDO}} = 1.8V \pm 0.2V; \text{ NOTE } 1$	1.2			V
			$V_{_{DDO}} = 3.3V \pm 5\%; \text{ NOTE 1}$			0.6	V
V <sub>ol</sub>	Output Low Voltage	•	$V_{_{DDO}} = 2.5V \pm 5\%; \text{ NOTE 1}$			0.5	V
			$V_{_{DDO}} = 1.8V \pm 0.2V; \text{ NOTE } 1$			0.4	V

NOTE 1: Outputs terminated with 50 $\Omega$  to V<sub>DDD</sub>/2. See Parameter Measurement section, "Load Test Circuit" diagrams.

### TABLE 5. CRYSTAL CHARACTERISTICS

Parameter	Test Conditions	Minimum	Typical	Maximum	Units
Mode of Oscillation		Fundamental			
Frequency		12		38.88	MHz
Equivalent Series Resistance (ESR)				50	Ω
Shunt Capacitance				7	pF
Drive Level				1	mW

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
f		w/external XTAL		12		38.88	MHz
MAX	Output Frequency	w/external CLK				200	MHz
tp	Propagation Delay, 1	Low-to-High; NOTE		1.4	1.9	2.4	ns
<i>t</i> sk(o)	Output Skew; NOTE 2					40	ps
<i>t</i> sk(pp)	Part-to-Part Skew; NOTE 2, 3					700	ps
<i>t</i> jit(Ø)	RMS Phase Jitter, I NOTE 2, 4	Random;	25MHz, Integration Range: 100Hz – 1MHz		0.16		ps
t <sub>R</sub> / t <sub>F</sub>	Output Rise/Fall Tir	ne	20% to 80%	100		800	ps
	Output	w/external XTAL		45		55	%
odc	Duty Cycle	w/external CLK	<i>f</i> < 150MHz	46		54	%
t <sub>en</sub>	Output Enable Time	e; NOTE 5				10	ns
t	Output Disable Tim	e; NOTE 5				10	ns

#### TABLE 6A. AC CHARACTERISTICS, $V_{DD} = V_{DDD} = 3.3V \pm 5\%$ , TA = 0°C to 70°C

NOTE 1: Measured from  $V_{DD}/2$  of the input to  $V_{DDD}/2$  of the output.

NOTE 2: This parameter is defined in accordance with JEDEC Standard 65.

NOTE 3: Defined as skew between outputs on different devices operating a the same supply voltages and

with equal load conditions. Using the same type of input on each device, the output is measured at V no. /2.

NOTE 4: Phase jitter is dependent on the input source used.

NOTE 5: These parameters are guaranteed by characterization. Not tested in production.

### TABLE 6B. AC CHARACTERISTICS, $V_{DD} = 3.3V \pm 5\%$ , $V_{DDD} = 2.5V \pm 5\%$ , TA = 0°C to 70°C

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
f		w/external XTAL		12		38.88	MHz
MAX	Output Frequency	w/external CLK				200	MHz
tp	Propagation Delay, Low-to-High; NOTE			1.5	2.0	2.5	ns
<i>t</i> sk(o)	Output Skew; NOTE 2					40	ps
<i>t</i> sk(pp)	Part-to-Part Skew; NOTE 2, 3					700	ps
<i>t</i> jit(Ø)	RMS Phase Jitter, Random; NOTE 2, 4		25MHz, Integration Range: 100Hz - 1MHz		0.16		ps
t <sub>R</sub> / t <sub>F</sub>	Output Rise/Fall Tir	ne	20% to 80%	100		800	ps
odc	Output	w/external XTAL		45		55	%
ouc	Duty Cycle	w/external CLK	<i>f</i> < 150MHz	46		54	%
t <sub>en</sub>	Output Enable Time; NOTE 5					10	ns
t DIS	Output Disable Tim	e; NOTE 5				10	ns

NOTE 1: Measured from  $V_{DD}/2$  of the input to  $V_{DD}/2$  of the output. NOTE 2: This parameter is defined in accordance with JEDEC Standard 65.

NOTE 3: Defined as skew between outputs on different devices operating a the same supply voltages and

with equal load conditions. Using the same type of input on each device, the output is measured at  $V_{_{DDO}}/2$ . NOTE 4: Phase jitter is dependent on the input source used.

NOTE 5: These parameters are guaranteed by characterization. Not tested in production.

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
£		w/external XTAL		12		38.88	MHz
MAX	Output Frequency w/external CLK					200	MHz
tp <sub>∟н</sub>	Propagation Delay, 1	Low-to-High; NOTE		1.7	2.2	2.7	ns
<i>t</i> sk(o)	Output Skew; NOTE 2					40	ps
<i>t</i> sk(pp)	Part-to-Part Skew; NOTE 2, 3					700	ps
<i>t</i> jit(Ø)	RMS Phase Jitter, I NOTE 2, 4	Random;	25MHz, Integration Range: 100Hz - 1MHz		0.16		ps
t <sub>_R</sub> / t <sub>_F</sub>	Output Rise/Fall Tir	ne	20% to 80%	100		1000	ps
	Output	w/external XTAL		45		55	%
odc	Duty Cycle	w/external CLK	<i>f</i> < 150MHz	46		54	%
t <sub>en</sub>	Output Enable Time	e; NOTE 5				10	ns
t	Output Disable Tim	e; NOTE 5				10	ns

#### **TABLE 6C. AC CHARACTERISTICS,** $V_{DD} = 3.3V \pm 5\%$ , $V_{DDD} = 1.8V \pm 0.2V$ , TA = 0°C to 70°C

NOTE 1: Measured from  $V_{DD}/2$  of the input to  $V_{DDD}/2$  of the output. NOTE 2: This parameter is defined in accordance with JEDEC Standard 65.

NOTE 3: Defined as skew between outputs on different devices operating a the same supply voltages and

with equal load conditions. Using the same type of input on each device, the output is measured at V pro/2.

NOTE 4: Phase jitter is dependent on the input source used.

NOTE 5: These parameters are guaranteed by characterization. Not tested in production.

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
f		w/external XTAL		12		38.88	MHz
MAX	Output Frequency	w/external CLK				200	MHz
tp	Propagation Delay, 1	Low-to-High; NOTE		1.5	2.2	3.0	ns
<i>t</i> sk(o)	Output Skew; NOTE 2					40	ps
<i>t</i> sk(pp)	Part-to-Part Skew; NOTE 2, 3					700	ps
<i>t</i> jit(Ø)	RMS Phase Jitter, Random; NOTE 2, 4		25MHz, Integration Range: 100Hz - 1MHz		0.20		ps
t <sub>R</sub> / t <sub>F</sub>	Output Rise/Fall Tir	ne	20% to 80%	100		800	ps
	Output	w/external XTAL		45		55	%
odc	Duty Cycle	w/external CLK	<i>f</i> < 150MHz	48		52	%
t <sub>en</sub>	Output Enable Time	e; NOTE 5				10	ns
t	Output Disable Tim	e; NOTE 5				10	ns

# TABLE 6D. AC CHARACTERISTICS, $V_{DD} = V_{DDD} = 2.5V \pm 5\%$ , TA = 0°C to 70°C

NOTE 1: Measured from  $V_{DD}/2$  of the input to  $V_{DDD}/2$  of the output.

NOTE 2: This parameter is defined in accordance with JEDEC Standard 65.

NOTE 3: Defined as skew between outputs on different devices operating a the same supply voltages and

with equal load conditions. Using the same type of input on each device, the output is measured at V\_no/2.

NOTE 4: Phase jitter is dependent on the input source used.

NOTE 5: These parameters are guaranteed by characterization. Not tested in production.

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
£		w/external XTAL		12		38.88	MHz
MAX	Output Frequency	w/external CLK				200	MHz
tp	Propagation Delay, 1	Low-to-High; NOTE		1.7	2.5	3.3	ns
<i>t</i> sk(o)	Output Skew; NOTE 2					40	ps
<i>t</i> sk(pp)	Part-to-Part Skew; NOTE 2, 3					700	ps
<i>t</i> jit(Ø)	RMS Phase Jitter, I NOTE 2, 4	Random;	25MHz, Integration Range: 100Hz - 1MHz		0.19		ps
t <sub>R</sub> / t <sub>F</sub>	Output Rise/Fall Tir	ne	20% to 80%	100		1000	ps
	Output	w/external XTAL		45		55	%
odc	Duty Cycle	w/external CLK	<i>f</i> < 150MHz	46		54	%
t <sub>en</sub>	Output Enable Time; NOTE 5					10	ns
t	Output Disable Tim	e; NOTE 5				10	ns

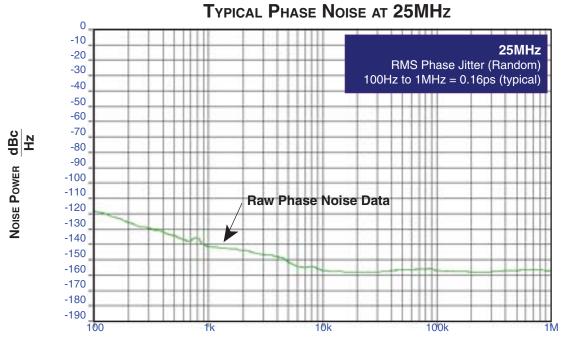
### TABLE 6E. AC CHARACTERISTICS, $V_{DD} = 2.5V \pm 5\%$ , $V_{DDD} = 1.8V \pm 0.2V$ , TA = 0°C to 70°C

NOTE 1: Measured from  $V_{DD}/2$  of the input to  $V_{DDD}/2$  of the output. NOTE 2: This parameter is defined in accordance with JEDEC Standard 65.

NOTE 3: Defined as skew between outputs on different devices operating a the same supply voltages and with equal load conditions. Using the same type of input on each device, the output is measured at  $V_{_{DDO}}/2$ .

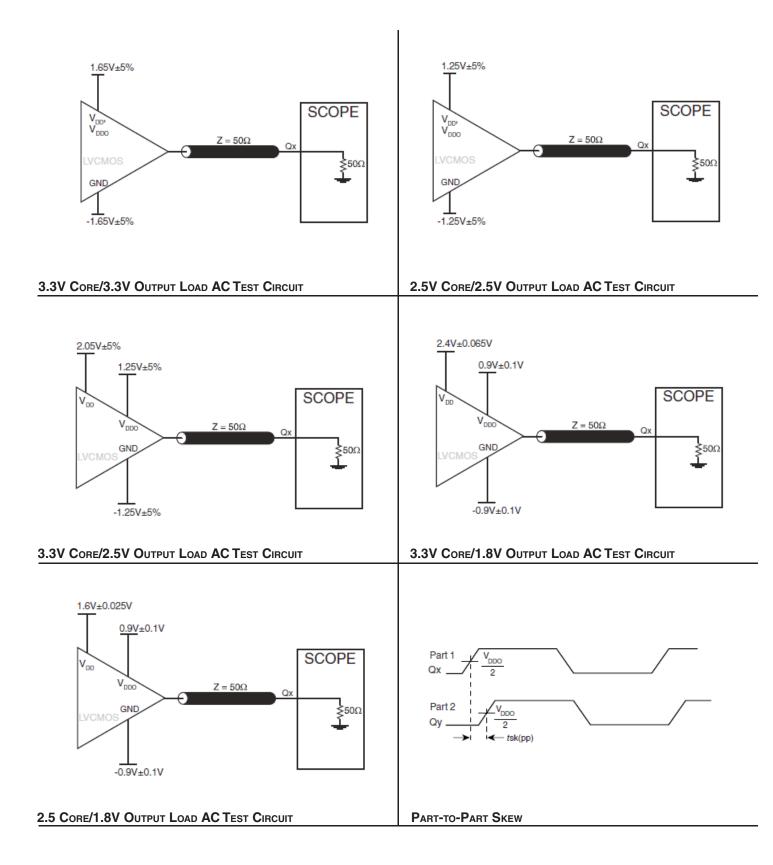
NOTE 4: Phase jitter is dependent on the input source used.

NOTE 5: These parameters are guaranteed by characterization. Not tested in production.

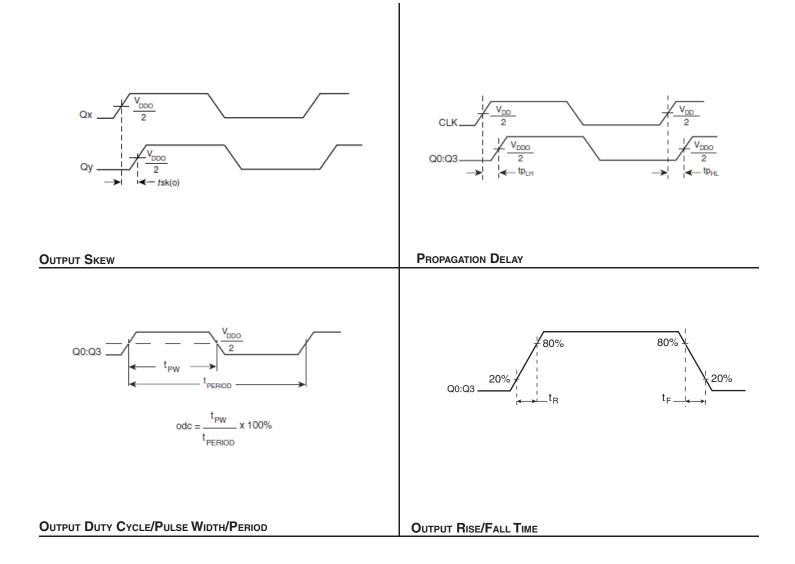


OFFSET FREQUENCY (Hz)









# **APPLICATION** INFORMATION

# RECOMMENDATIONS FOR UNUSED INPUT AND OUTPUT PINS

#### **INPUTS:**

#### **C**RYSTAL INPUTS

For applications not requiring the use of the crystal oscillator input, both XTAL\_IN and XTAL\_OUT can be left floating. Though not required, but for additional protection, a  $1k\Omega$  resistor can be tied from XTAL\_IN to ground.

#### **CLK** INPUT

For applications not requiring the use of the clock input, it can be left floating. Though not required, but for additional protection, a  $1k\Omega$  resistor can be tied from the CLK input to ground.

#### SELECT PINS

All select pins have internal pull-ups and pull-downs; additional resistance is not required but can be added for additional protection. A  $1k\Omega$  resistor can be used.

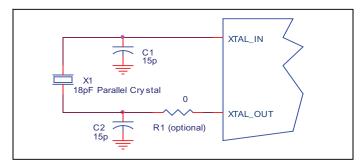
# **O**UTPUTS:

#### LVCMOS OUTPUTS

All unused LVCMOS output can be left floating. There should be no trace attached.

# **CRYSTAL INPUT INTERFACE**

*Figure 1* shows an example of 83904-02 crystal interface with a parallel resonant crystal. The frequency accuracy can be fine tuned by adjusting the C1 and C2 values. For a parallel crystal with loading capacitance CL = 18pF, we suggest C1 = 15pF and C2 = 15pF to start with. These values may be slightly fine tuned further to optimize the frequency accuracy for different board layouts. Slightly increasing the C1 and C2 values will slightly reduce the frequency. Slightly decreasing the C1 and C2 values will slightly increase the frequency. For the oscillator circuit below, R1 can be used, but is not required. For new designs, it is recommended that R1 not be used.





### OVERDRIVING THE CRYSTAL INTERFACE

The XTAL\_IN input can a single-ended LVCMOS signal through an AC coupling capacitor. A general interface diagram is shown in Figure 2A. The XTAL\_OUT pin can be left floating. The maximum amplitude of the input signal should not exceed 2V and the input edge rate can be as slow as 10ns. This configuration requires that the output impedance of the driver (Ro) plus the series resistance (Rs) equals the transmission line impedance. In addition, matched termination at the crystal input will attenuate the signal in half. This can be done in one of two ways. First, R1 and R2 in parallel should equal the transmission line impedance. For most 50 $\Omega$  applications, R1 and R2 can be 100 $\Omega$ . This can also be accomplished by removing R1 and making R2 50 $\Omega$ . By overdring the crystal oscillator, the device will be functional, but note, the device performance is guaranteed by using a quartz crystal.

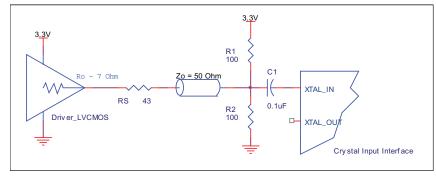


FIGURE 2A. GENERAL DIAGRAM FOR LVCMOS DRIVER TO XTAL INPUT INTERFACE

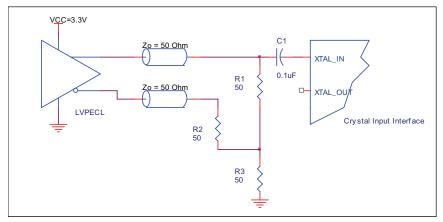


FIGURE 2A. GENERAL DIAGRAM FOR LVPECL DRIVER TO XTAL INPUT INTERFACE

# **R**ELIABILITY INFORMATION

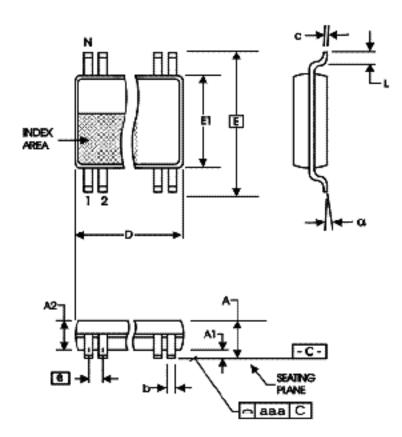
# TABLE 7. $\boldsymbol{\theta}_{_{JA}} \text{vs.}$ Air Flow Table for 16 Lead TSSOP

θ <sub>JA</sub> by Velocity (Linear Feet per Minute)						
0	1	2.5				
100.3°C/W	96.0°C/W	93.9°C/W				
	0	0 1	0 1 2.5			

#### TRANSISTOR COUNT

The transistor count for 83904-02 is: 205

PACKAGE OUTLINE - G SUFFIX FOR 16 LEAD TSSOP



### TABLE 8. PACKAGE DIMENSIONS

SYMBOL	Millimeters				
STMDOL	Minimum	Maximum			
N	16				
А		1.20			
A1	0.05	0.15			
A2	0.80	1.05			
b	0.19	0.30			
с	0.09	0.20			
D	4.90	5.10			
E	6.40 E	BASIC			
E1	4.30	4.50			
е	0.65 E	BASIC			
L	0.45	0.75			
α	0°	8°			
aaa		0.10			

Reference Document: JEDEC Publication 95, MO-153

# TABLE 9. ORDERING INFORMATION

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
83904AG-02LF	3904A02L	16 Lead "Lead-Free" TSSOP	tube	0°C to 70°C
83904AG-02LFT	3904A02L	16 Lead "Lead-Free" TSSOP	tape & reel	0°C to 70°C

# RENESAS

	REVISION HISTORY SHEET							
Rev	Table	Page	Description of Change	Date				
A	Т9	14	Updated Overdriving the Crystal Interface section. Ordering Information Table - deleted the "ICS" prefix in the Part/Order Number column and corrected the Temperature column. Updated header/footer.	9/3/10				
Α	Т9	14	Ordering Information - Removed leaded devices. Updated data sheet format.	3/25/15				
A	Т9		Ordering Information - Deleted LF note below table. Updated header and footer.	3/17/16				



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